

RoHS

COMPLIANT HALOGEN

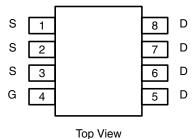
FREE

**Vishay Siliconix** 

### N-Channel 30 V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
30	0.016 at V <sub>GS</sub> = 10 V	11.9	5.5 nC			
30	0.020 at $V_{GS}$ = 4.5 V	10.6	5.5110			





#### **Ordering Information:**

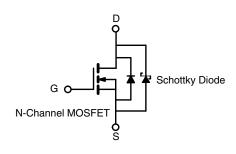
Si4776DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 ٠ Definition
- SkyFET<sup>®</sup> Monolithic TrenchFET<sup>®</sup> Power MOSFET and Schottky Diode
- 100 % R<sub>g</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

Notebook System Power and Memory - Low Side



<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub>	= 25 °C, unless othe	rwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	30	v	
Gate-Source Voltage	V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		11.9	
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	9.5	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C		9.3 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	=	7.5 <sup>b, c</sup>	А
Pulsed Drain Current (t = 300 µs)	I <sub>DM</sub>	50	A .	
Orational Designation	T <sub>C</sub> = 25 °C	L.	3.7	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub> -	2.3 <sup>b, c</sup>	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	10	
Single Pulse Avalanche Energy		E <sub>AS</sub>	5	mJ
	T <sub>C</sub> = 25 °C		4.1	
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C	Р	2.6	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	$t \le 10 s$	R <sub>thJA</sub>	40	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	24	30	C/W	

Notes:

a. Based on  $T_C = 25$  °C.

b. Surface mounted on 1" x 1" FR4 board. c. t = 10 s.

d. Maximum under steady state conditions is 95 °C/W.

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### Si4776DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		·		•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 1 \text{ mA}$	30			v	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1		2.3	v	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Oata Maltana Duain Ourmant	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		0.013	0.150	mA	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$		1	10		
On -State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 5 \text{ V},  V_{GS} = 10 \text{ V}$	30			Α	
	Б	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		0.013	0.016		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7 A		0.016	0.020	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		30		S	
Dynamic <sup>b</sup>		·					
Input Capacitance	C <sub>iss</sub>			521			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		141		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	1		57			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		11.6	17.5	nC	
				5.5	8.5		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 10 A		1.5			
Gate-Drain Charge	Q <sub>gd</sub>			1.9			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			12	24		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		12	24		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 10 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		14	28		
Fall Time	t <sub>f</sub>			8	16	-	
Turn-On Delay Time	t <sub>d(on)</sub>			10	20	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		11	22		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		11	22		
Fall Time	t <sub>f</sub>			6	12		
Drain-Source Body Diode and Schottky	Characterist	lics		•			
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			3.7	А	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	А	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1 A		0.44	0.55	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			12	24	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	-		4.5	9	nC	
Reverse Recovery Fall Time	ta	$I_{F} = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_{J} = 25 ^{\circ}\text{C}$		6.5			
Reverse Recovery Rise Time	t <sub>b</sub>			5.5		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

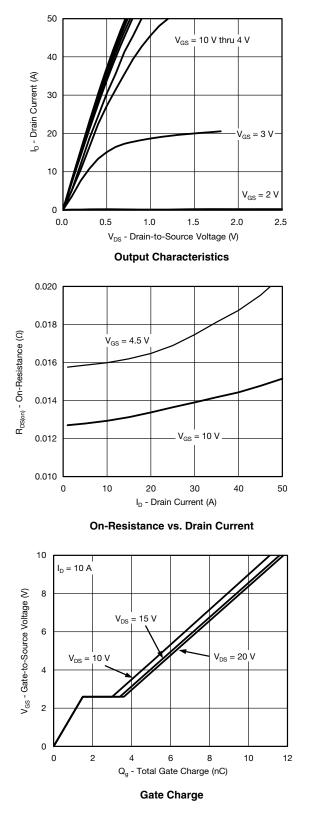
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

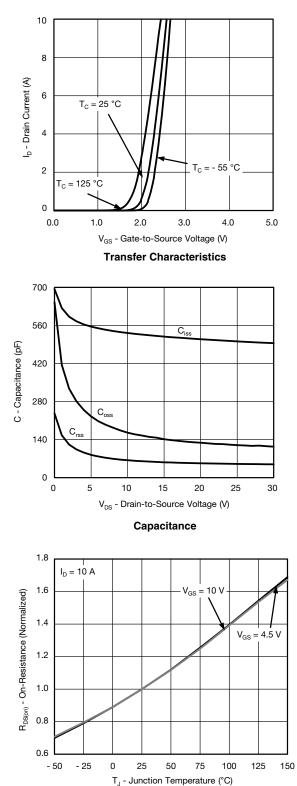
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### Si4776DY Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





**On-Resistance vs. Junction Temperature** 

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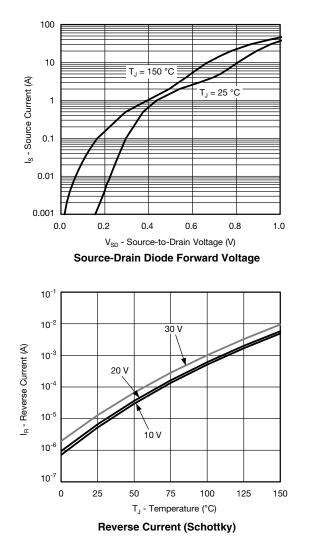
3

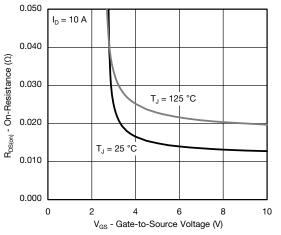
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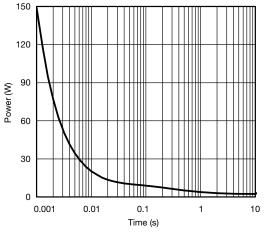


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

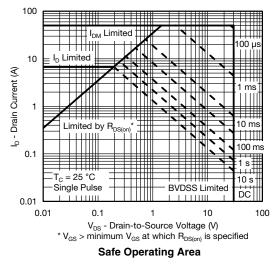




**On-Resistance vs. Gate-to-Source Voltage** 



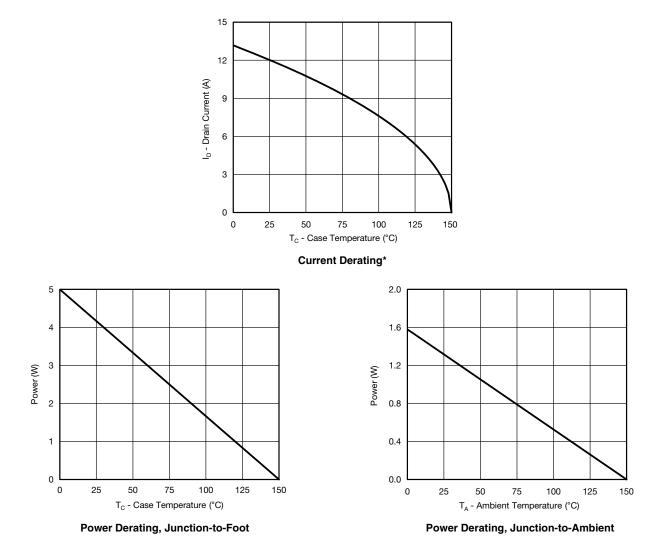
Single Pulse Power, Junction-to-Ambient





### Si4776DY Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



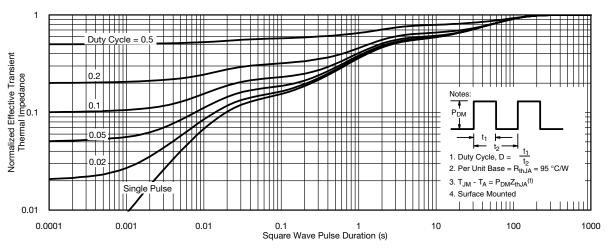
\* The power dissipation P<sub>D</sub> is based on T<sub>J(max)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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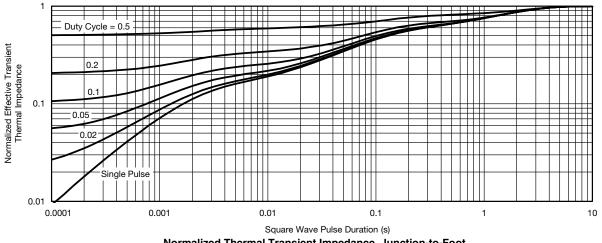
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Normalized Thermal Transient Impedance, Junction-to-Foot

'Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?63316">www.vishay.com/ppg?63316</a>.

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# Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

## **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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